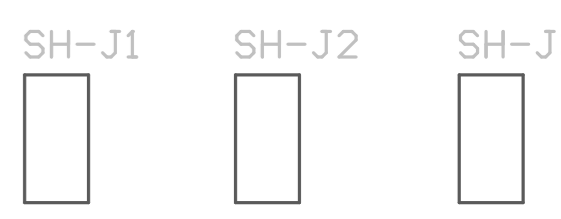


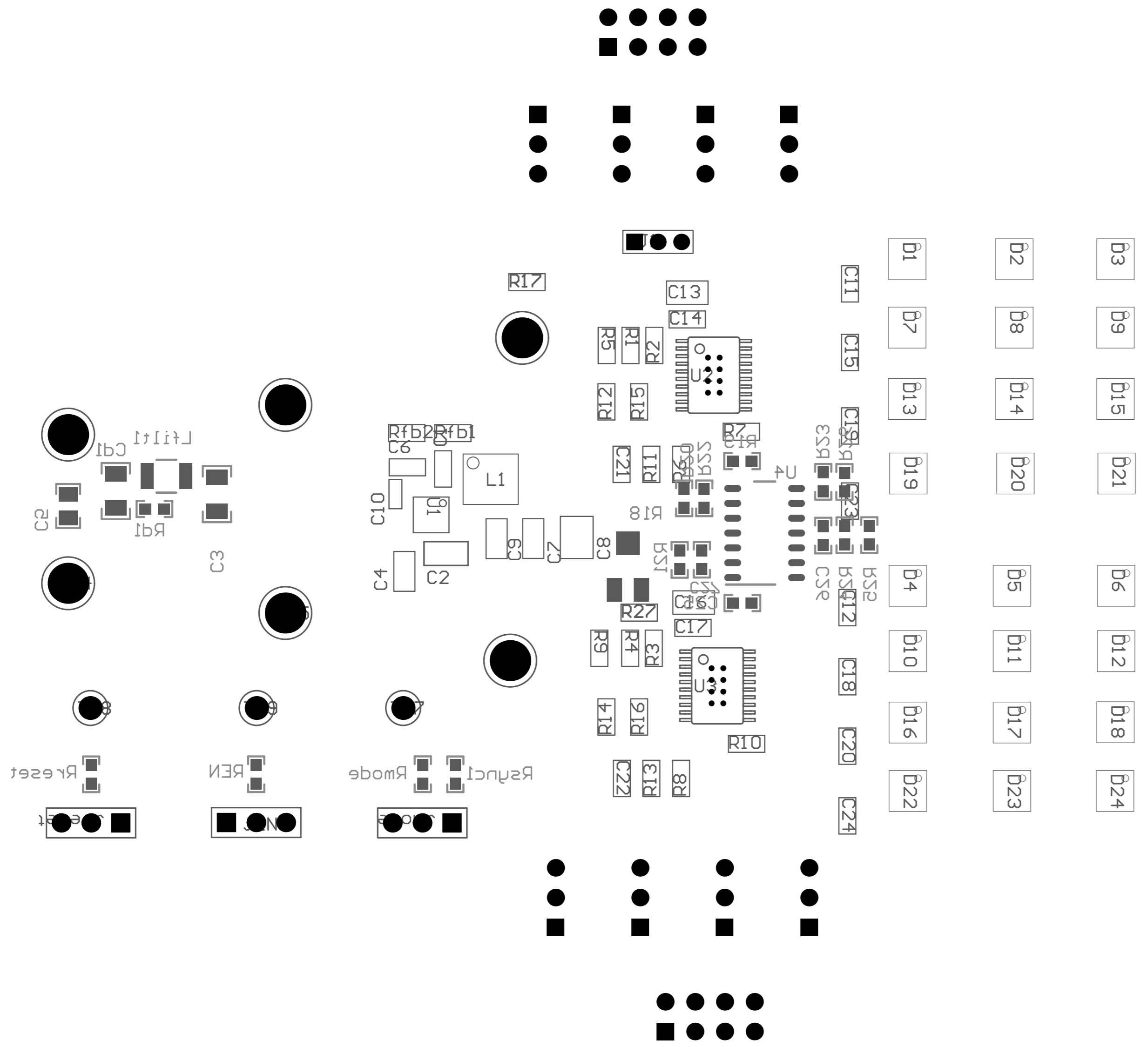
TIDA-01348
Automotive LED Lighting



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.

ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-01348	REV: A	SUN REV: Not In VersionControl
Top Overlay	TID #: TIDA-01348		
PLOT NAME = Component SideAssembly Drawing	GENERATED : 9/26/2016	2:54:07 PM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.

ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-01348	REV: A	SUN REV: Not In VersionControl
Bottom Overlay	TID #: TIDA-01348		
PLOT NAME = Solder SideAssembly Drawing	GENERATED : 9/26/2016 2:54:08 PM	TEXAS INSTRUMENTS	

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Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
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